

RD39 Status Report 2006

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<http://rd39.web.cern.ch/RD39/>

Outline

Introduction

Trapping effect on Charge Collection efficiency (CCE) in S-LHC

Cryogenic TCT setup

CCE at the low temperatures

Operation of current-injected-detectors (CID)

CCE measurements on CID

Simulation of noise in CID strip detectors

Cryogenic module of microstrip Si detectors

Milestones and Budget

Trapping effect on CCE in S-LHC

$$CCE = CCE_{GF} \times CCE_t = \frac{w}{d} \cdot e^{-t_{dr}/\tau_t}$$

Trapping term (points to e^{-t_{dr}/τ_t})
Depletion term (points to $\frac{w}{d}$)

- Overall CCE is product of
- CCE_t is trapping factor
 - CCE_{GF} is geometrical factor

$$w = \sqrt{\frac{2\epsilon\epsilon_0 V}{eN_{eff}}} \quad \text{and} \quad \frac{w}{d} = \sqrt{\frac{V}{V_{fd}}}$$

For fluence less than 10^{15} n/cm², the trapping term CCE_t is significant

For fluence 10^{16} n/cm², the trapping term CCE_t is a limiting factor of detector operation !

TRAPPING

$$\tau_t = \frac{1}{\sigma v_{dr} N_t}$$

The drift velocity $v_{dr} \approx 10^7 \text{ cm/s}$

10^{16} cm^{-2} irradiation produces $N_T \approx 3-5 \times 10^{16} \text{ cm}^{-3}$ with $\sigma \approx 10^{-14} \text{ cm}^2$

On average (e and h) it gives a $\tau_f \approx 0.2 \text{ ns!}$

Even in highest E-field (Saturation velocity, 10^7 cm/s), carrier drifts only 20-30 μm before it gets trapped regardless whether the detector is fully depleted or not !

In S-LHC conditions, about 90% of the volume of $d=300 \mu\text{m}$ detector is dead space !

DETRAPPING

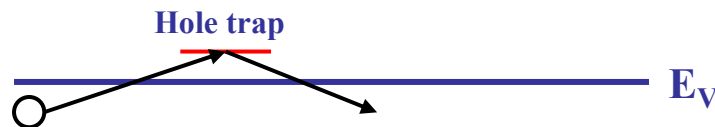
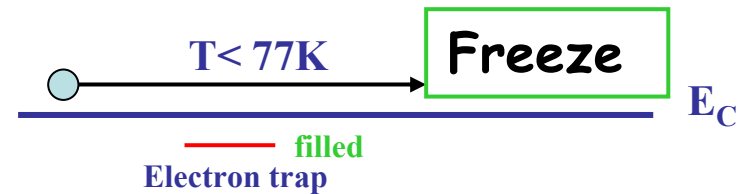
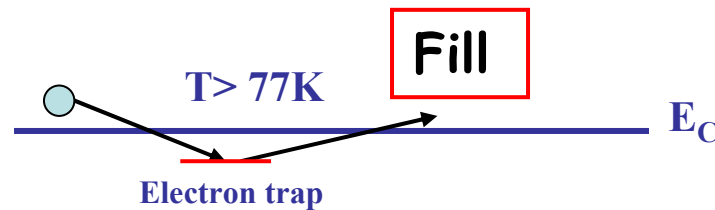
$$\tau_d = \frac{1}{\sigma v_{th} N_C e^{-E_t/kT}}$$

If a trap is filled (electrically non-active) the detrapping time-constant is crucial

The detrapping time-constant depends exponentially on T

For A-center (O-V at $E_c - 0.18$ eV with $\sigma \approx 10^{-15}$ cm²)

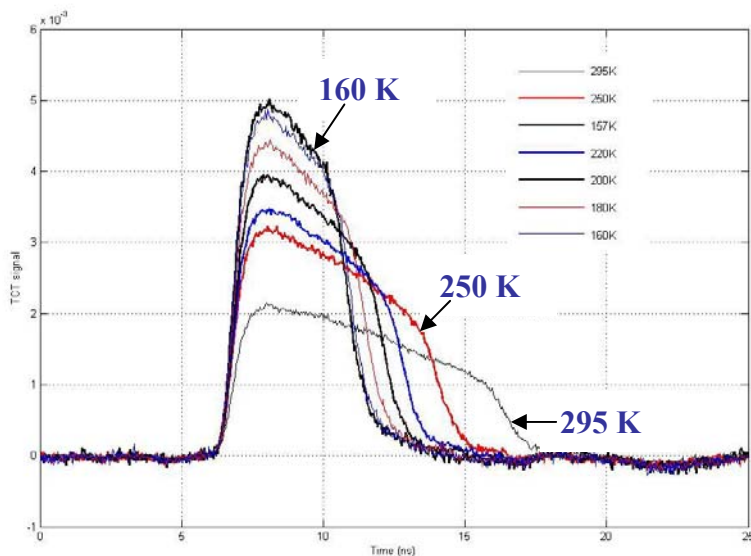
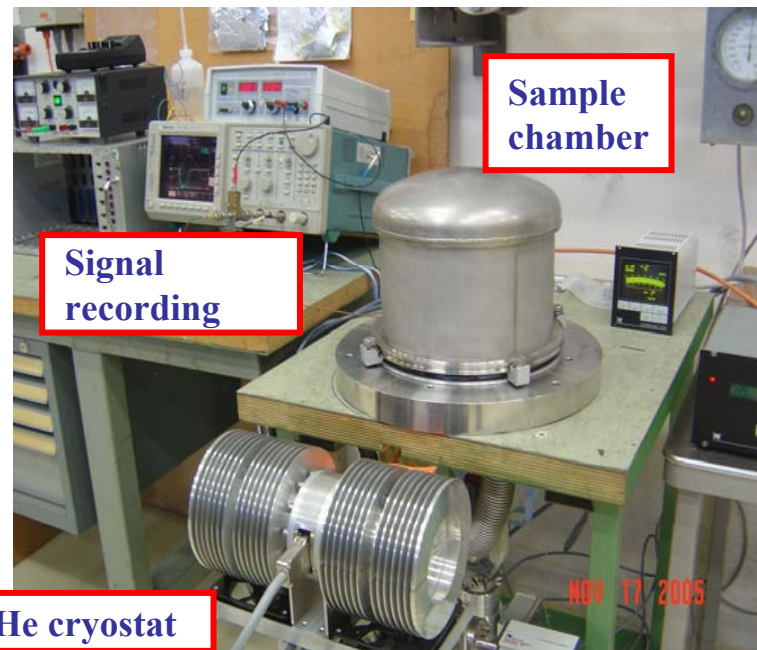
T(K)	300	150	100	77	60	55	50	48	47	46
τ_d	3.7 ns	3.9 μ s	4 ms	2 s	1.22 hrs	1.2 days	53 days	302 days	2.1 years	5.47 years



Cryogenic Transient Current Technique (C-TCT)

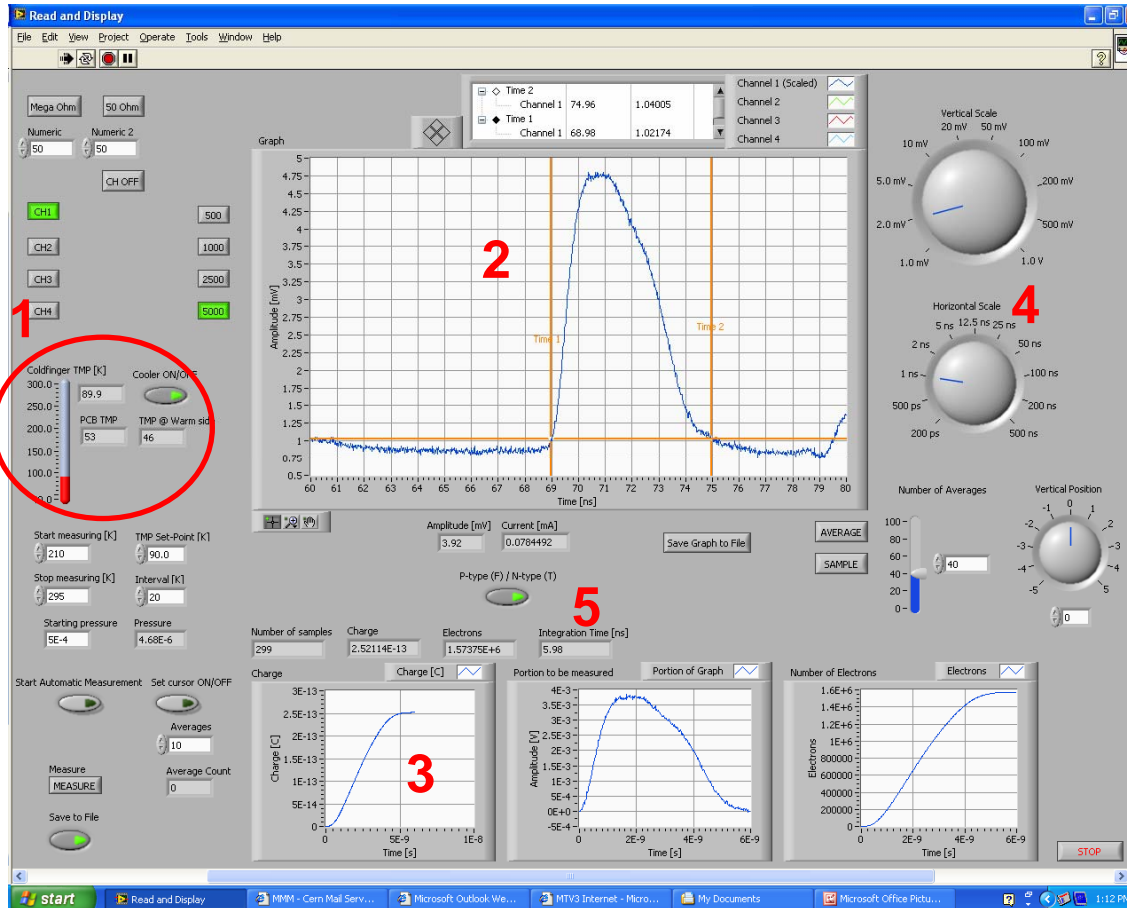
With C-TCT it is possible to measure and extract

- Full depletion voltage V_{fd}
- Charge Collection Efficiency (CCE)
- Type of the space charge (n or p)
- Trapping time constant $\tau_{e,h}$
- Electric field distribution $E(x)$



Improvements since Dec 2005

Fully computer controlled user interface

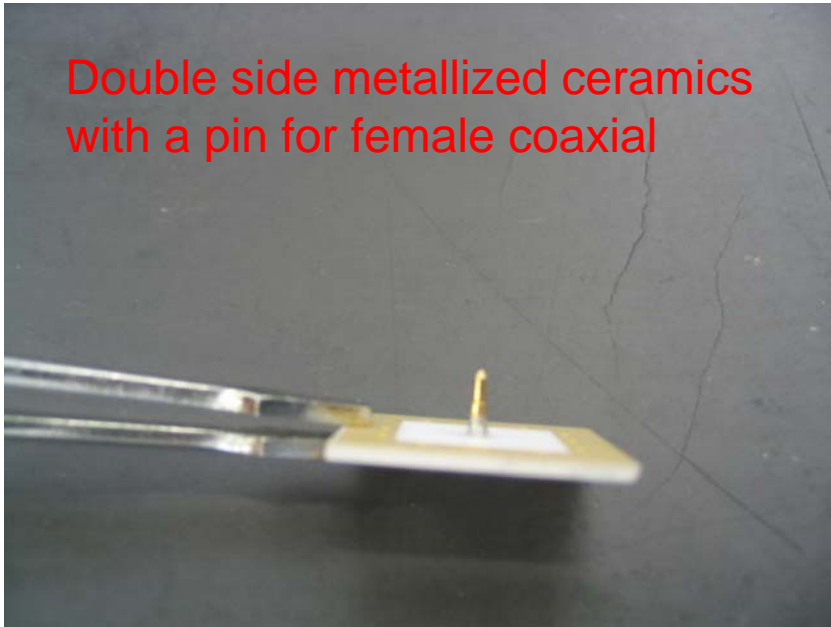


1. Temperature control
2. Adjustable cursors for data taking
3. CCE measurement screen
4. Oscilloscope control
5. N or P type sample

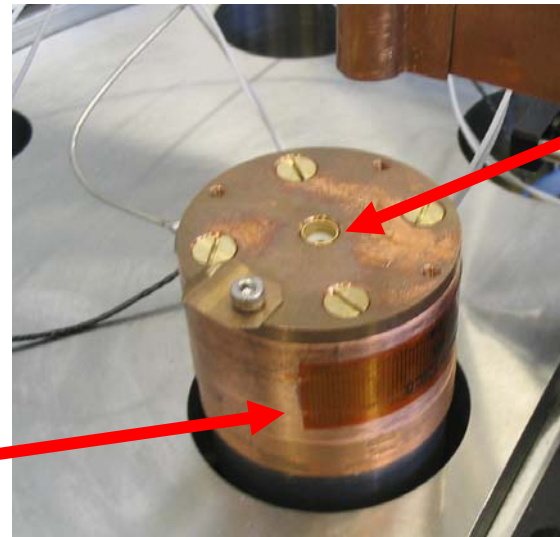
Improvements since Dec 2005

- Ceramic sample holders

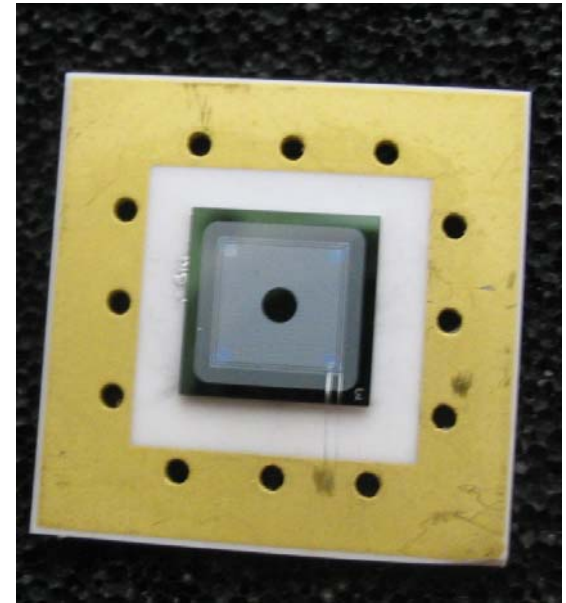
Double side metallized ceramics
with a pin for female coaxial



Heating resistor provides faster
temperature ramping

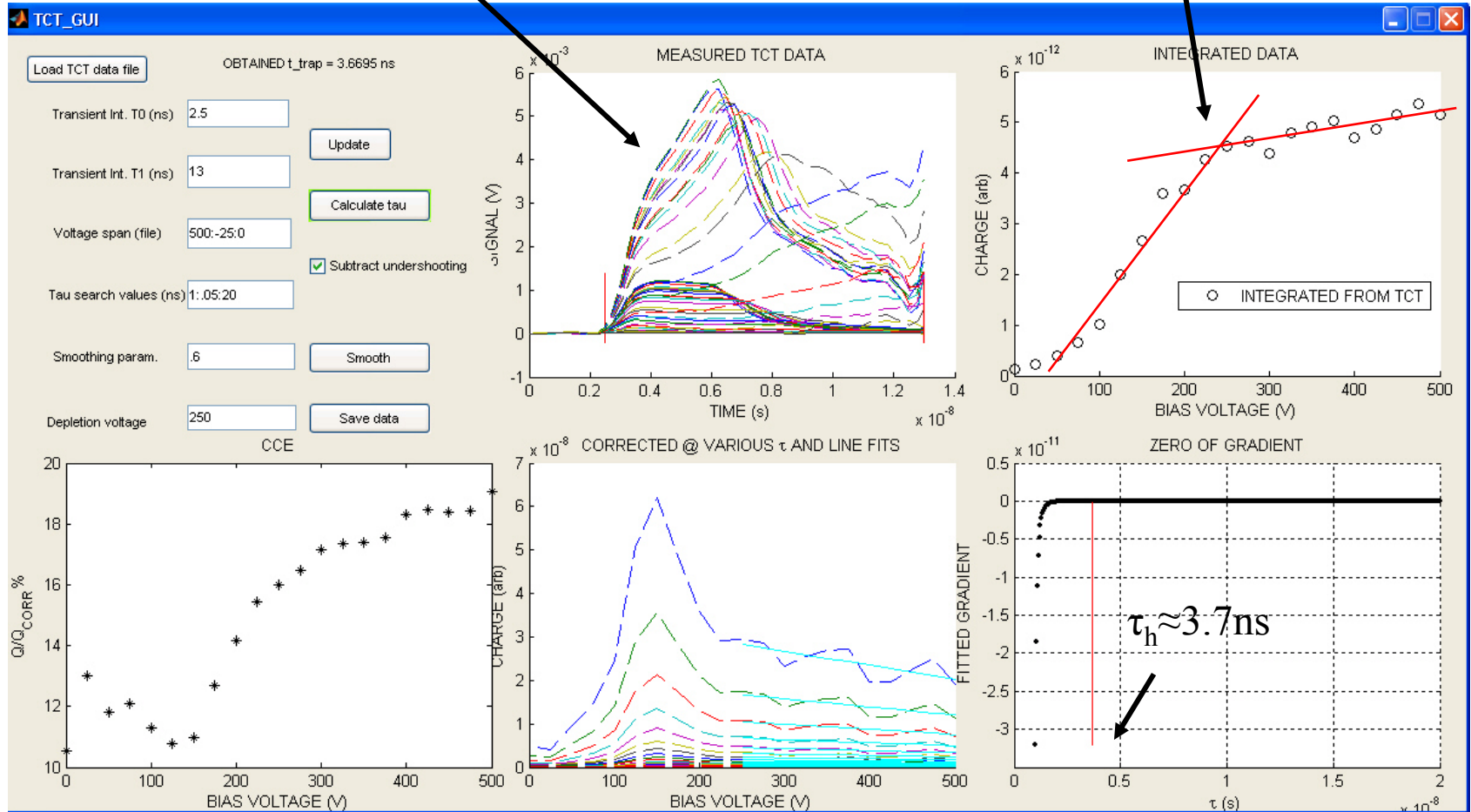


Cold finger
and coaxial
connector

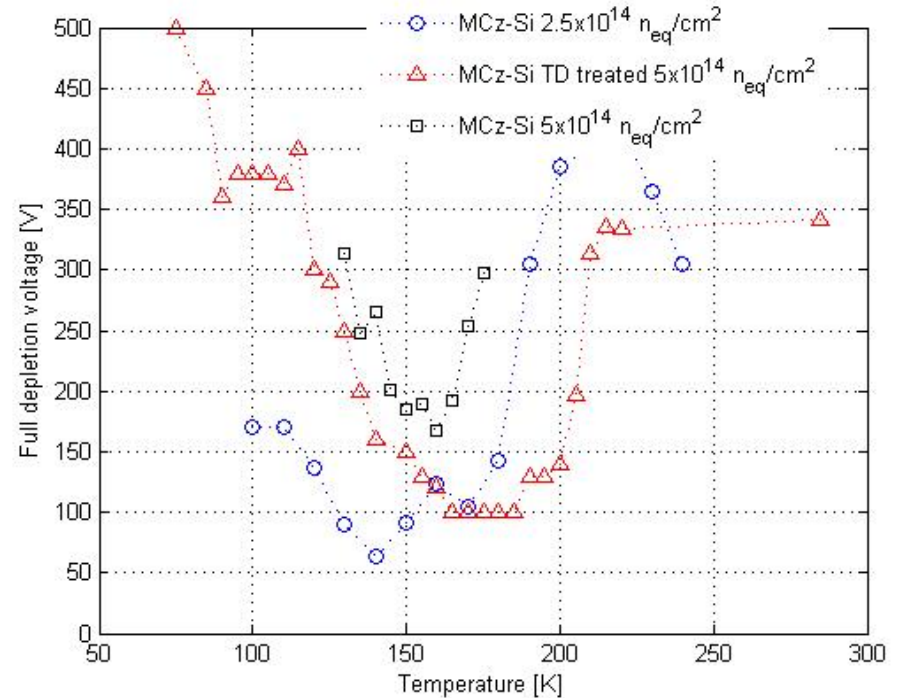
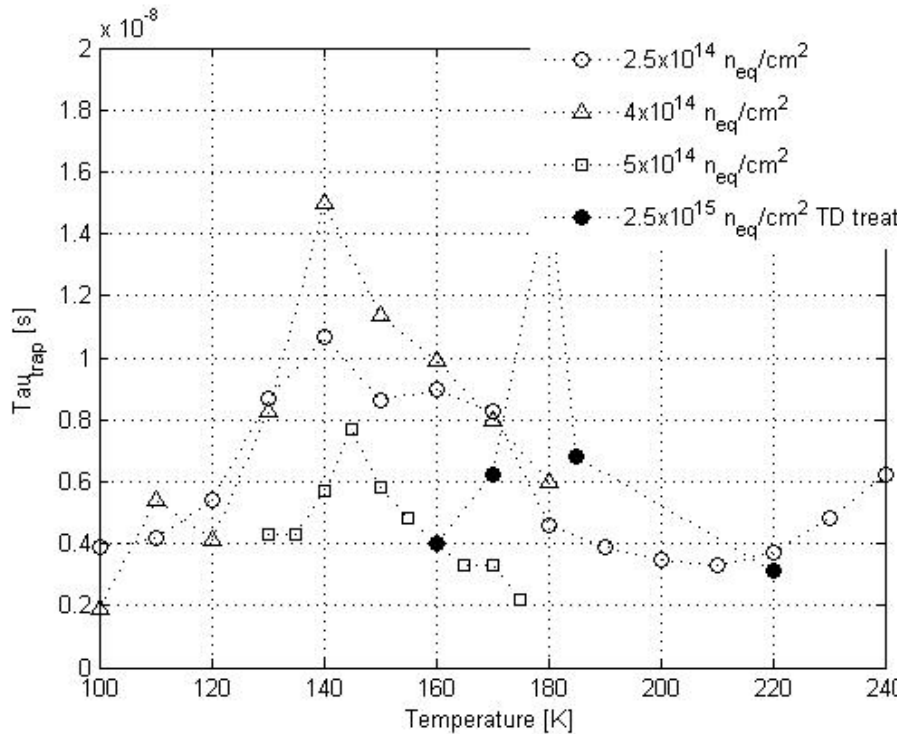


C-TCT data analysis

Trapping corrected transient



Trapping time τ_{eff} and V_{fd} vs Temperature

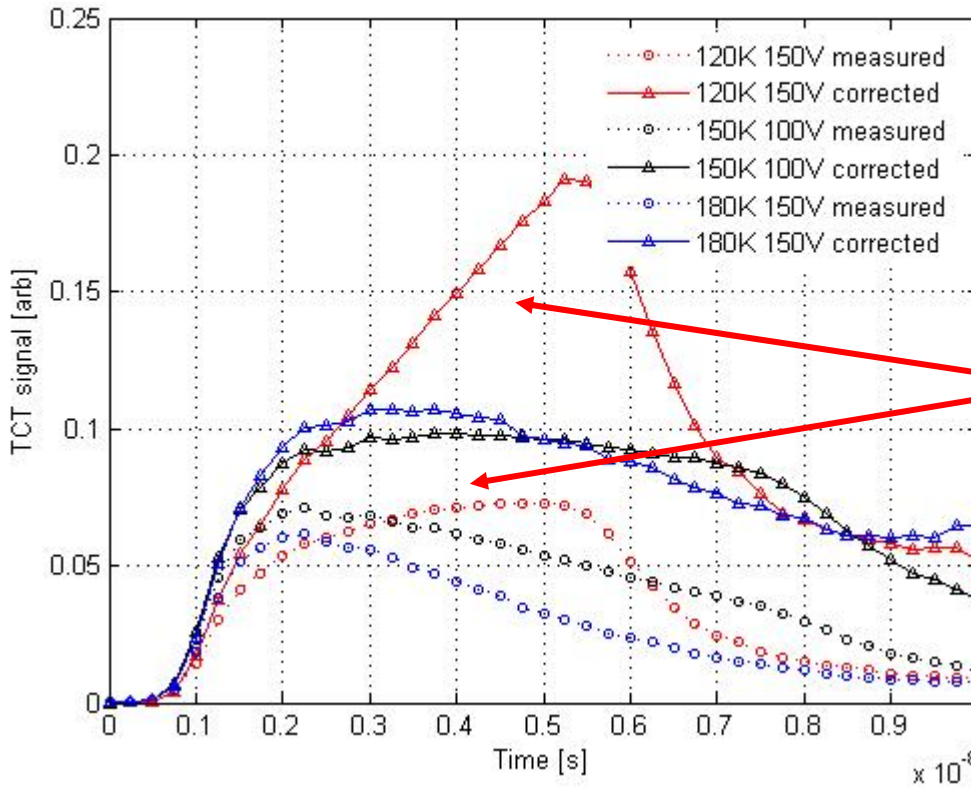


$$\tau_t = \frac{1}{\sigma v_{th} N_t}$$

Heavily irradiated n⁺/p⁻/p⁺ Magnetic Cz-Si detector
At room temperature $V_{\text{fd}} > 500\text{V}$

$$\tau_d = \frac{1}{\sigma v_{th} N_C e^{-E_t/kT}}$$

Space Charge Sign Inversion at low T



Decreasing transient 150K & 180K

Increasing transient 120K

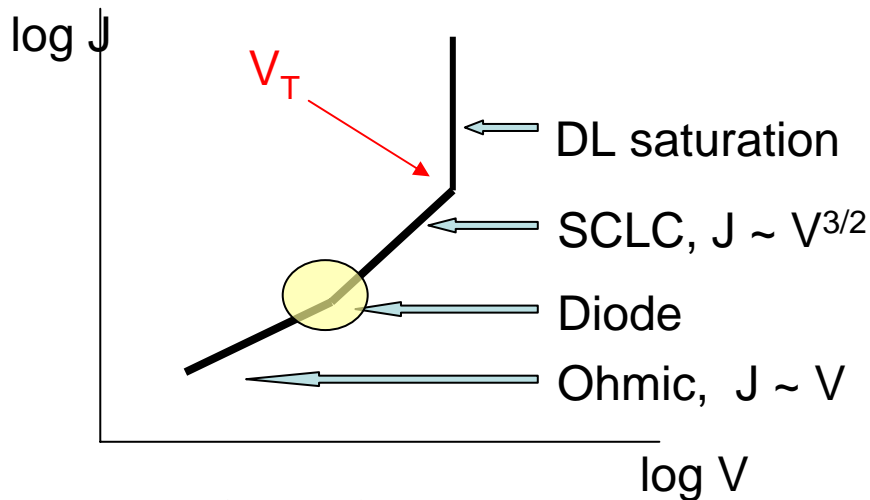
Space Charge is balanced by trapping and detrapping !

→ High E field → Low V_{fd}

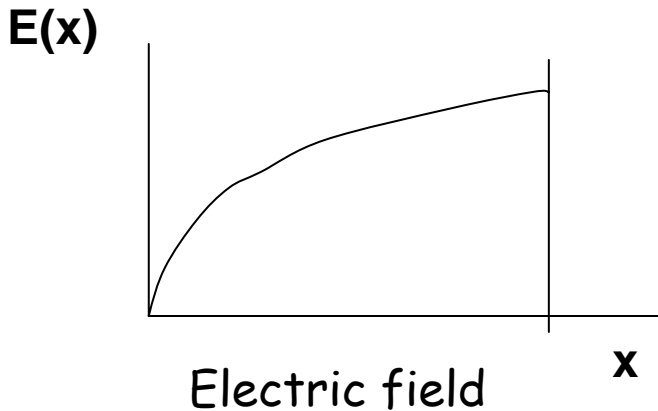
→ Higher τ_{trap}

$$\tau_t = \frac{1}{\sigma v_{th} N_t} \quad \tau_d = \frac{1}{\sigma v_{th} N_C e^{-E_t/kT}}$$

Charge Injected Detector CID



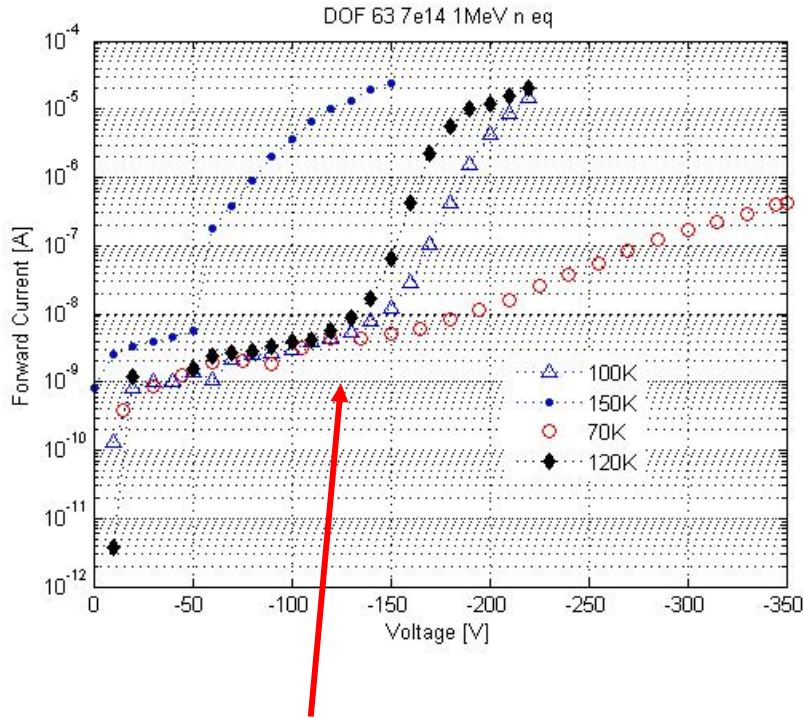
Current voltage characteristic



Features of CID

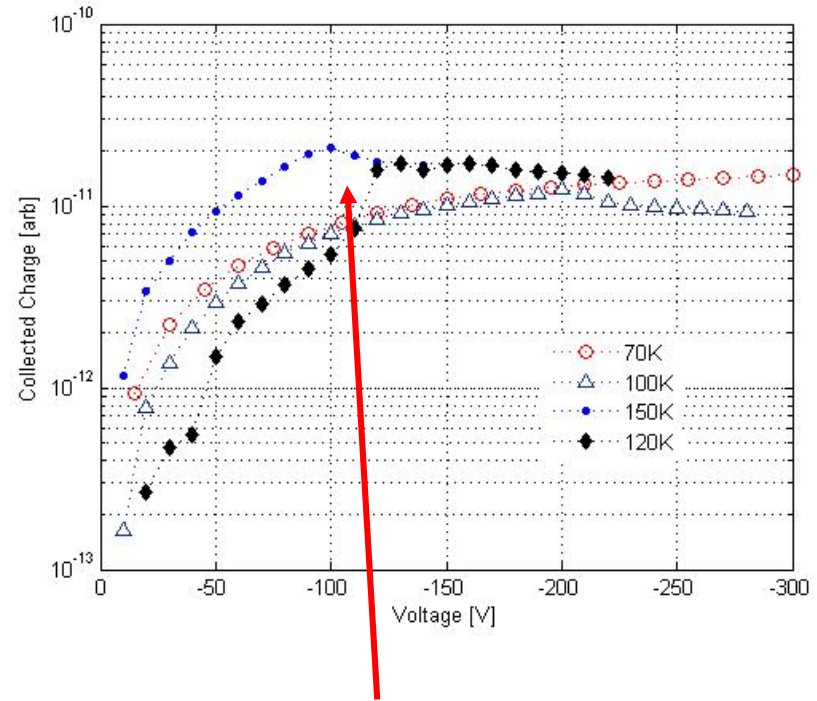
- * Electric field shape is not affected by fluence \gg E-field exists at S-LHC conditions
- * E field exists regardless of thickness
- * Low temperature makes possible to keep forward current at μA range
- * No breakdown problem due to self-adjusted electric field by space charge limited current feedback effect
- * CID is quite insensitive on detectors material properties.
- * CID is insensitive on type of irradiation.
- * CID is insensitive on reverse annealing of radiation defects \gg important in HEP applications.
- * Threshold for sharp current increase V_T increases with respect of fluence
- * V_T can be affected by temperature

Charge Collection in CID



Space charge saturation threshold V_T

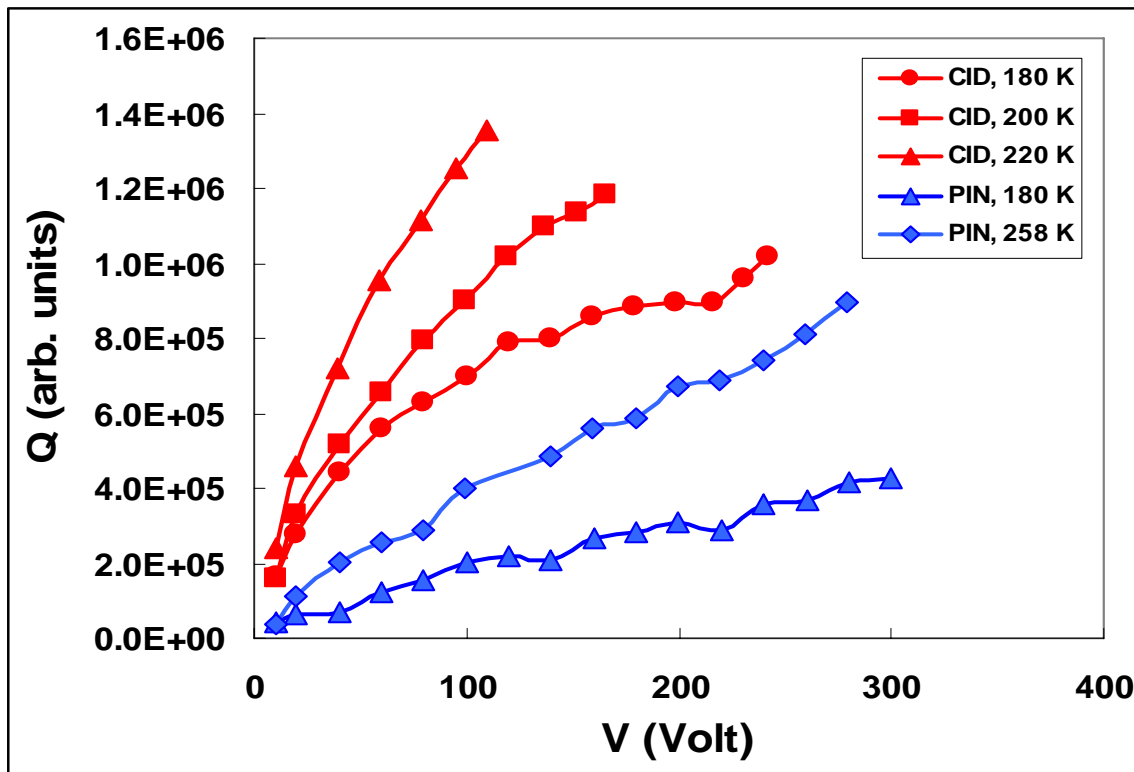
Measurements done with 670nm laser



CCE plateau after V_T

$$V_T = \frac{q}{\epsilon\epsilon_0} d^2 (N_{dl} - N_{dl}^+)$$

CCE of CID vs. "normal" detector PIN

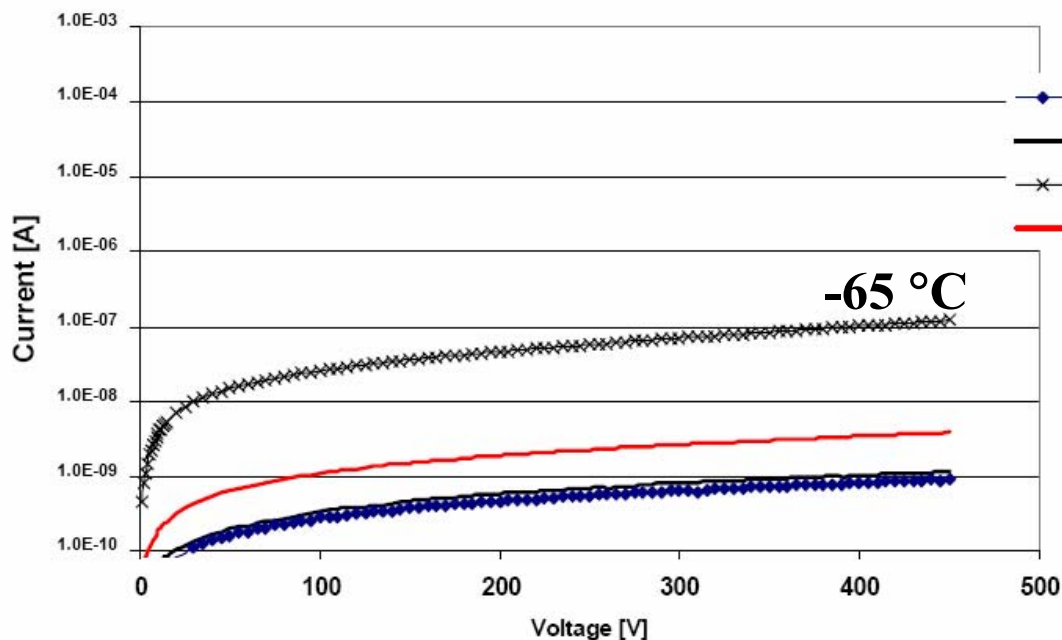


1060nm Infrared laser
simulates MIPs

Fluence $1 \times 10^{15} \text{ cm}^{-2}$

$V_{fd} \approx 1000\text{V}$ in normal
reverse biased operation

CID operation at S-LHC fluence



$J_{\text{forw}} \approx 100 \text{ nA/cm}^2$ at -65°C
 after $7 \times 10^{15} \text{ 1MeV } n_{\text{eq}}/\text{cm}^2$
 irradiation.
 $V_T > 450\text{V}$

MCz-Si 9MeV proton irradiated $7 \times 10^{15} \text{ 1MeV } n_{\text{eq}}/\text{cm}^2$

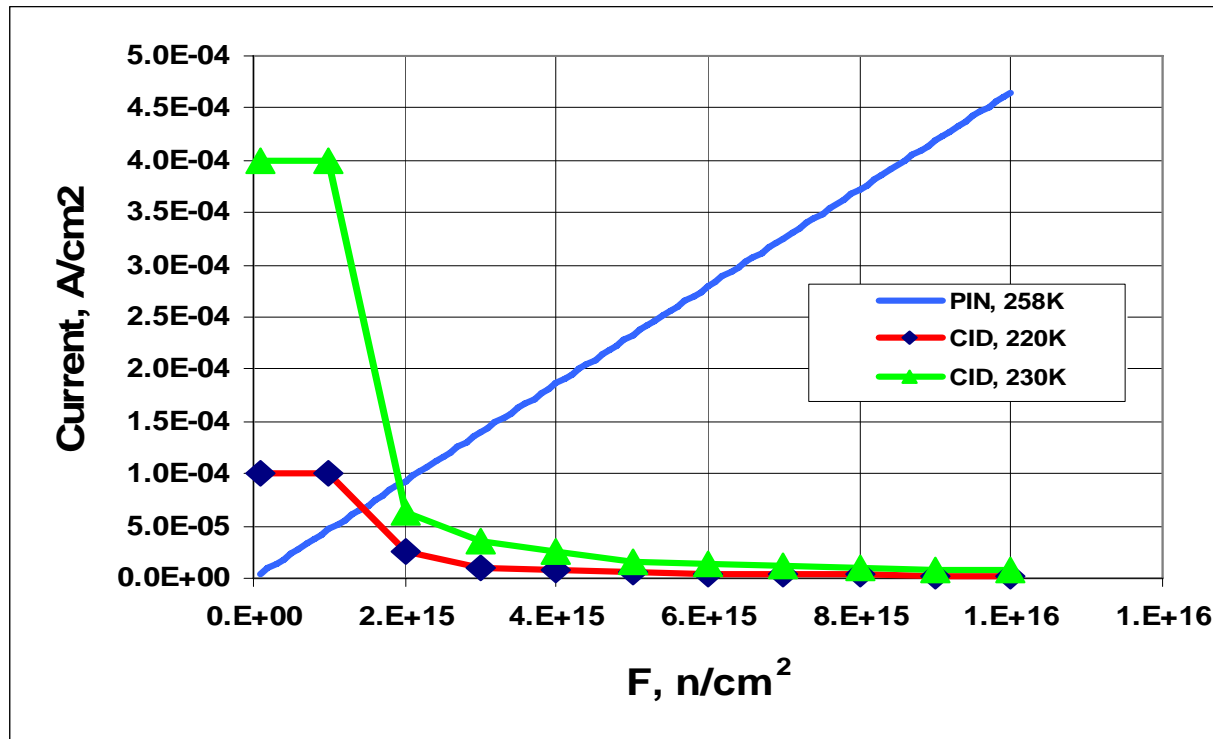
Current of CID and PIN

Simulation parameters:

-DL introduction rate – $4 \times 10^{12} \text{cm}^{-3}$ at $1 \times 10^{15} \text{n/cm}^2$

- $V_{CID} = 200 \text{V}$

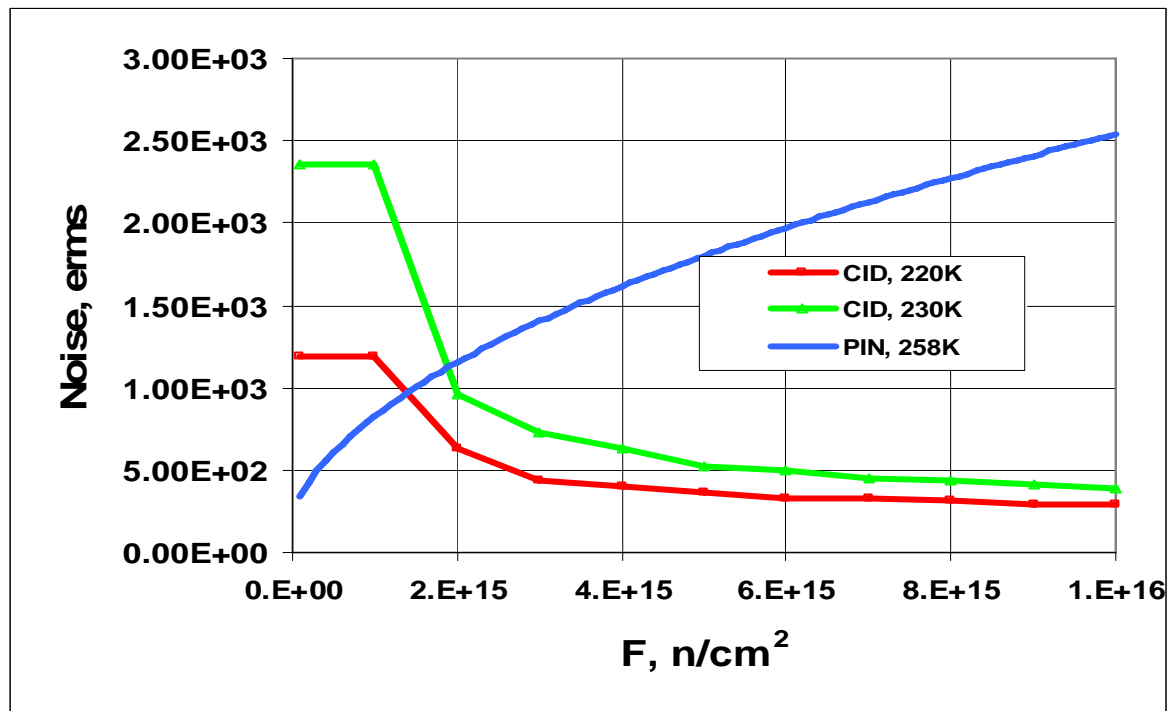
- $V_{pin} > V_{fd}$



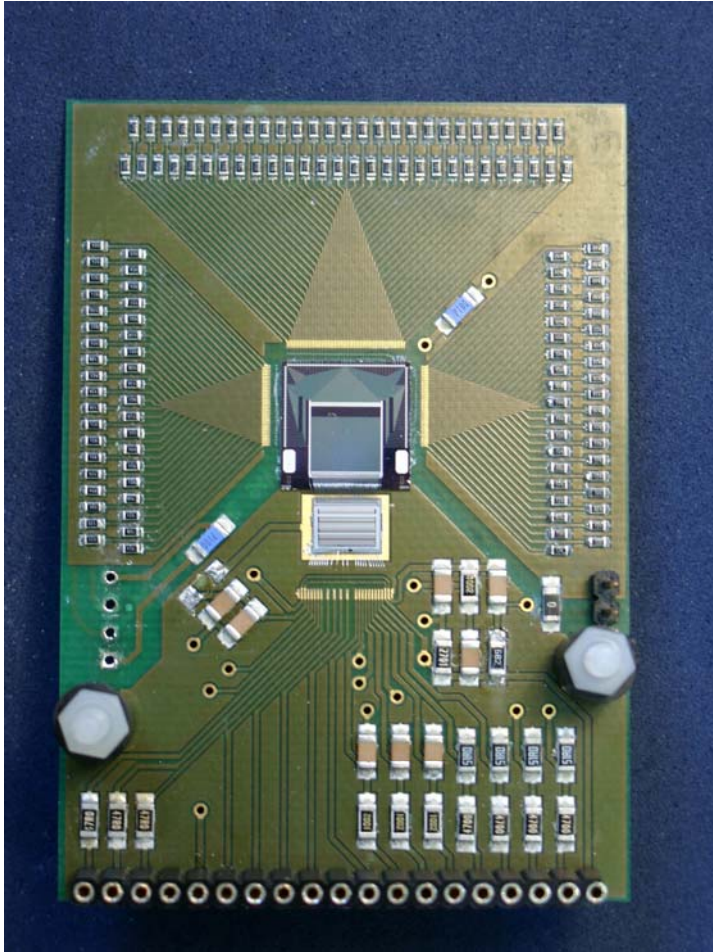
Noise in CID strip detector

Simulation parameters:

- ATLAS strip design, pitch $80\mu\text{m}$, length 6cm , shaping time 25ns
- CID at 200V
- PIN at $V=V_{fd}$ and 258K



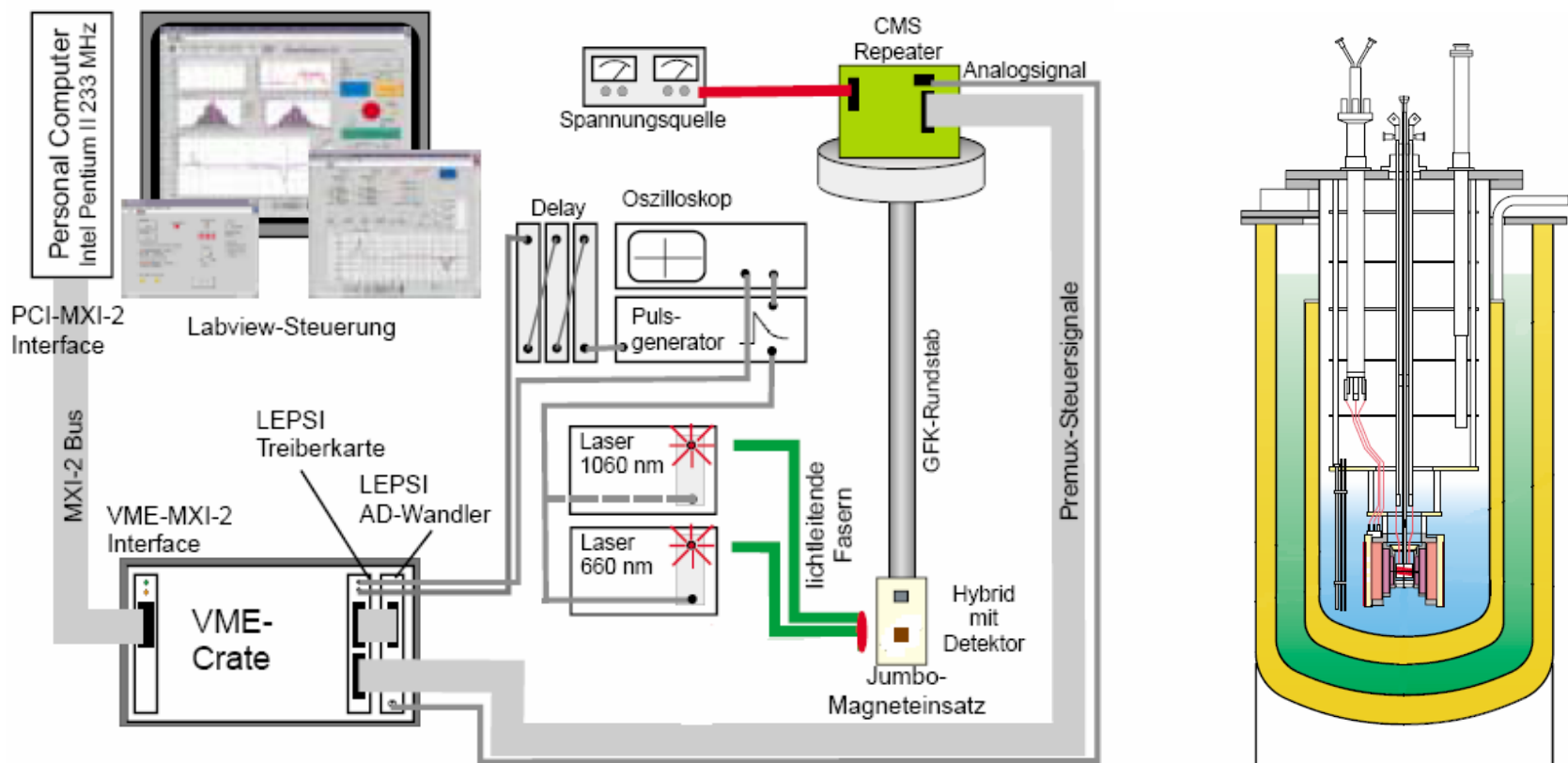
Hybrid with strip sensor



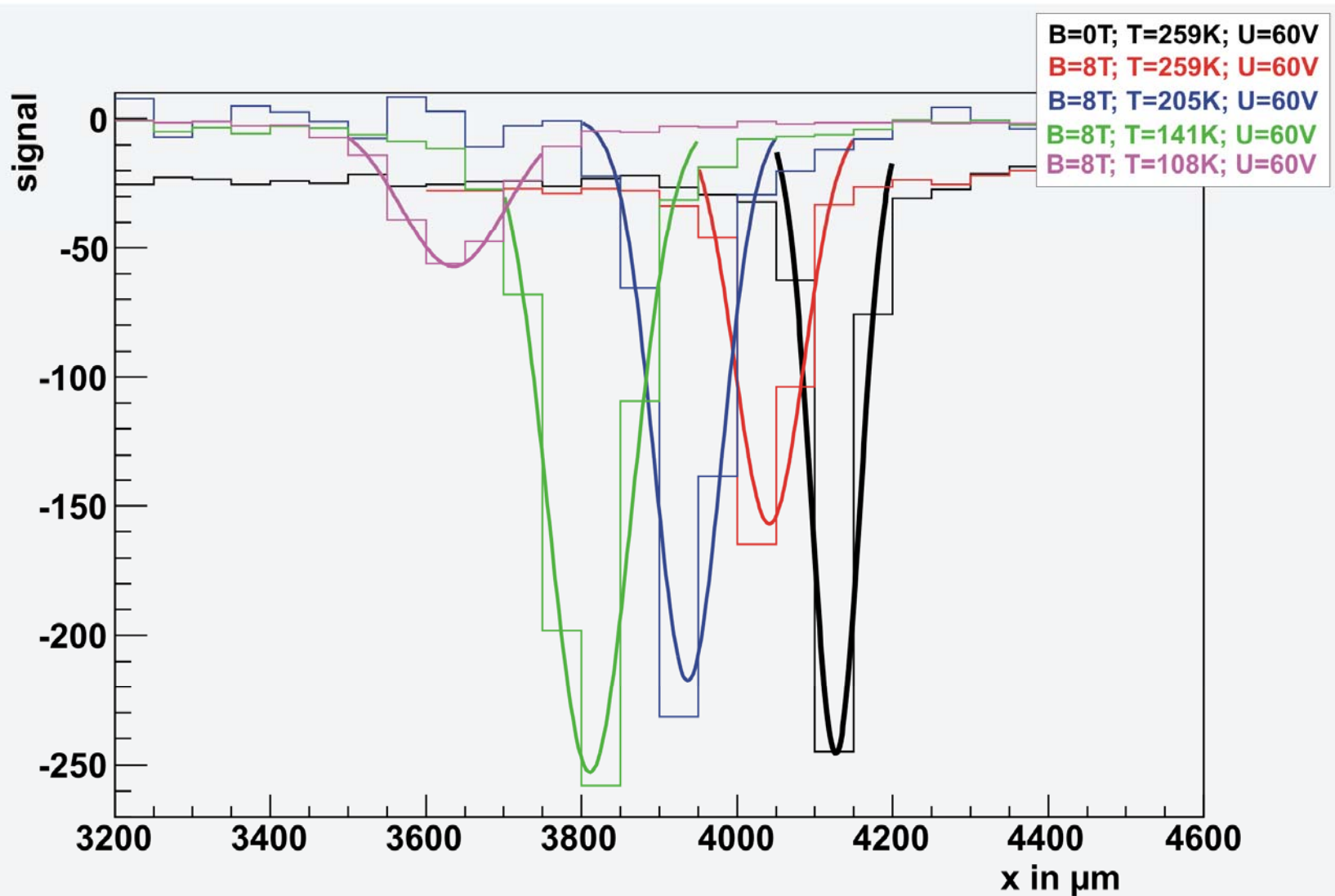
- Double sided sensor ($\sim 1\text{cm}^2$), $50\mu\text{m}$ pitch, $300\mu\text{m}$ thickness, strips on both sides parallel (former sensors had stripes crossed)
- bias resistors ($10\text{M}\Omega$) on hybrid
- Premux128 Chip for data recording
- irradiated with 26MeV protons
- $\Phi = 6 \times 10^{13}$ and $\Phi = 1,2 \times 10^{14}$

Karlsruhe Cryogenic TCT/CCE measurement setup

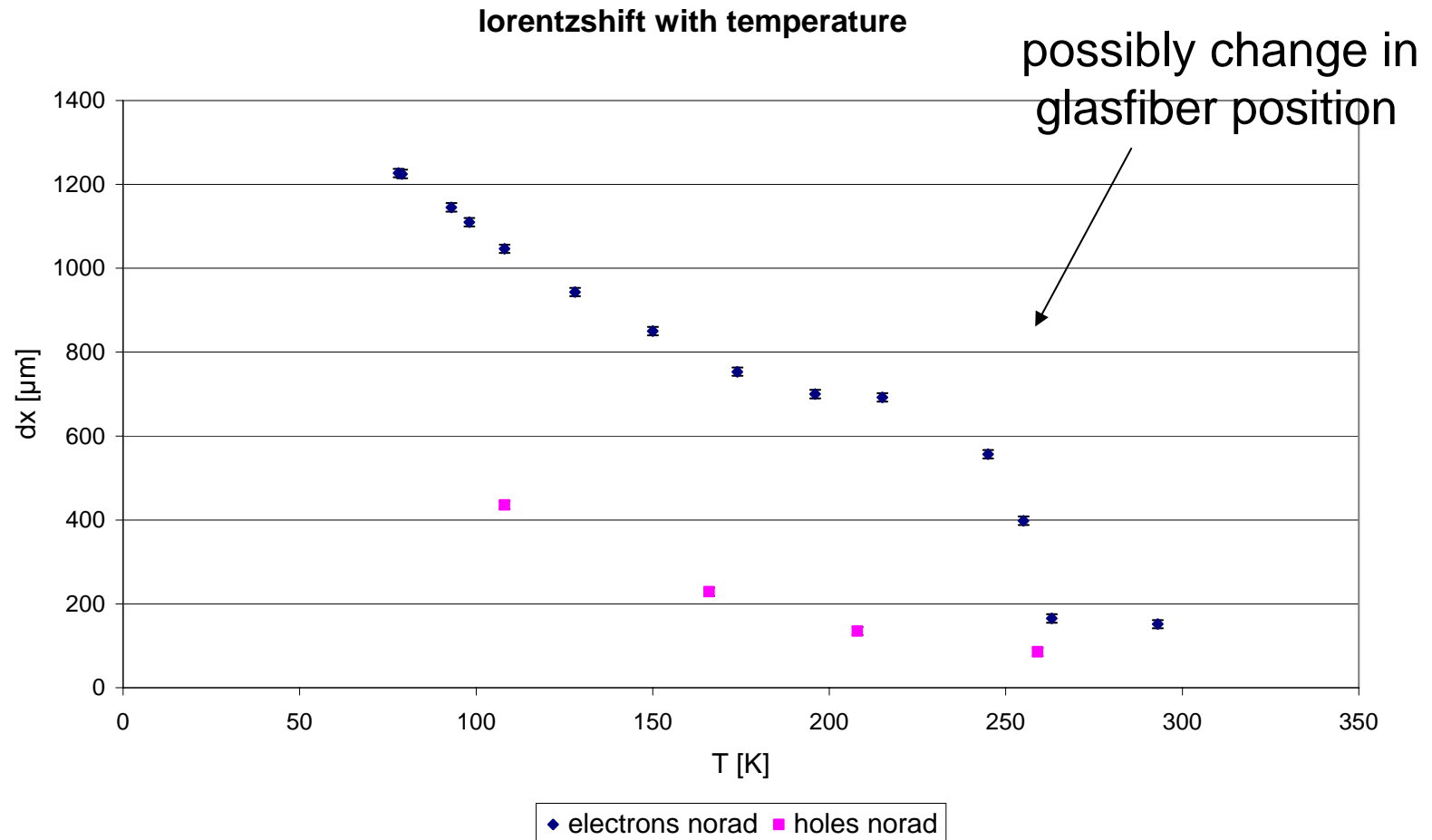
- The setup has extensively been used for Lorenzshift measurements
- Ongoing activity for CID measurements of strip detectors



Lorentzshift of holes with different temperatures



Lorentzshift of electrons and holes vs temperature



Summary

- The C-TCT project has been successfully completed
- The results show that at low temperatures the effective space charge is balanced by the trapping and detrapping.
- That results in

- 1) Space Charge Sign Inversion SCSI
- 2) Low full depletion voltage (measured by QV)
- 3) Increase of trapping time

•In CID detectors

- 1) E-field exists at any bias and at any fluence. Detector is always "fully depleted"
- 2) CCE measurements on CID at cryogenic temperatures with laser and forward current injection have shown significant increase in CCE
- 3) Simulations on ERMS noise predict that noise in CID strip detectors could be significantly lower than reverse biased detector operating at -15°C

Schedule for the projects of RD39 in 2006 and 2007

Device physics

Task name	2006				2007			
	Qtr 1	Qtr 2	Qtr 3	Qtr 4	Qtr 1	Qtr 2	Qtr 3	Qtr 4
Device Physics/ Basic Research								
Radiation of segmented (strip) Si detectors			X		XXX			
Improvements on the Cryo-TCT (C-TCT) by adding a floating power - Simulations of injection and E field.					XXX			
CID measurements at T<80 K for pad detectors by red and IR lasers			XX		XXXXXXXXXXXX			
CID measurements at T<80 K for strip detectors by red and IR lasers					XXXXXXXXXXXX			
More detailed CID modeling			XX		XXXXXXXXXXXXXXXXXXXX			
Simulations of injection and E field at cryogenic temperatures					XXXXXXXXXXXX			
Modeling of trapping at CID conditions at low temperatures					XXXXXXXXXXXXXXXXXXXX			

Schedule for the projects of RD39 in 2006 and 2007 II

Full size systems

Cryogenic Modules		
Characterization of CID operation of irradiated strip detectors with read-out electronics	XXX	XXXXXXXXXX
Laser cut and ICP Plasma etching of edgeless CMS baby strip detectors	XXX	X
Assembly of modules with edgeless CMS baby strip detectors		XXXXXXXX
Electrical tests of modules at low temperatures		XXX
Irradiation of modules		XX
Source and beam tests of irradiated modules		XXXX
ICP Plasma etching of edgeless detectors	XXX	XX

Resources

Resources of the 15 institutes in RD39, planned for the projects of RD39 for 2007. For institutes involved also directly in the experiments, the resources for the construction of the final detectors are not included in the figures given for the budget and for the FTE manpower.

Institute	Authors	Device Physics	Basic Research	Cryogenic Modules	RD39 Budget (CHF/year)	FTE In RD39
U. Northeastern	5	x	x		5000	1.00
BNL	2	x	x	x	20000	1.00
CERN	2	x	x		2000	1.00
U. Florence	4	x	x		4000	1.00
U. Geneva	1	x		x	1000	0.15
U. Glasgow	2	x	x		2000	0.50
HIP Helsinki	4	x	x		20000	1.00
U. Helsinki	4	x	x		10000	2
U. Karlsruhe	7	x	x		5000	2.00
U. Louvain	3	x		x	20000	1.00
JSI Ljubljana	4	x	x		2000	0.50
U. Naples	3			x	2000	0.50
Ioffe PTI	3	x	x	x	10000	1.50
U. Turku	3	x	x		5000	0.60
U. Vilnius	7	x	x		10000	2.0
Total	54	14	12	5	113000	14.75